

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

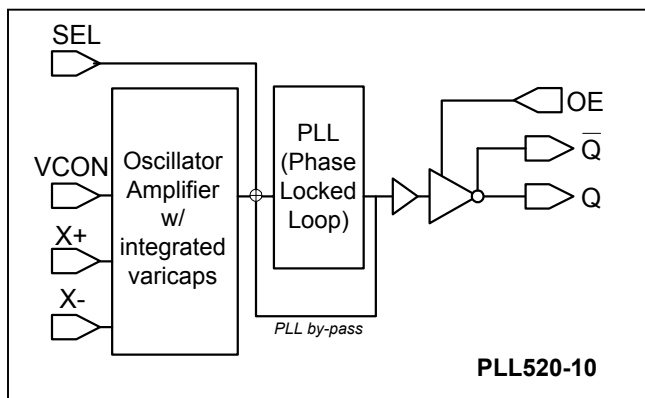
FEATURES

- 65MHz to 130MHz Fundamental Mode Crystal.
- Output range: 65MHz – 800MHz (selectable 1x, 2x, 4x and 8x multipliers).
- Low Injection Power for crystal 50uW.
- Available outputs: PECL, LVDS, or CMOS (High Drive (30mA) or Standard Drive (10mA) output).
- Integrated variable capacitors.
- Supports 3.3V-Power Supply.
- Available in die form.
- Thickness 10 mil.

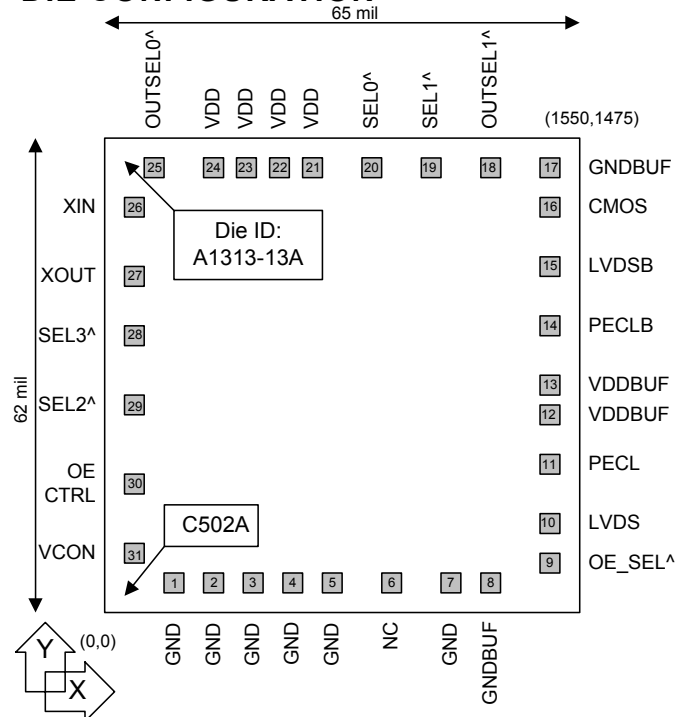
DESCRIPTION

PLL520-10 is a VCXO IC specifically designed to pull frequency fundamental crystals from 65MHz to 130MHz, with an integrated Phase Locked Loop for selectable 1x (no PLL), 2x, 4x or 8x multipliers. Its design was optimized to tolerate higher limits of interelectrode capacitance and bonding capacitance to improve yield. It achieves very low current into the crystal resulting in better overall stability. Its internal varicaps allow an on chip frequency pulling, controlled by the VCON input.

BLOCK DIAGRAM



DIE CONFIGURATION



DIE SPECIFICATIONS

Name	Value
Size	62 x 65 mil
Reverse side	GND
Pad dimensions	80 micron x 80 micron
Thickness	10 mil

OUTPUT SELECTION AND ENABLE

OUTSEL1 (Pad #18)	OUTSEL0 (Pad #25)	Selected Output
0	0	High Drive CMOS
0	1	Standard CMOS
1	0	LVDS
1	1	PECL (default)

OE_SELECT (Pad #9)	OE_CTRL (Pad #30)	State
0	0	Tri-state
	1 (Default)	Output enabled
1 (Default)	0 (Default)	Output enabled
	1	Tri-state

Pad #9: Bond to GND to set to "0", bond to VDD to set to "1"
 Pad #30: Logical states defined by PECL levels if OE_SELECT (pad #9) is "1"
 Logical states defined by CMOS levels if OE_SELECT is "0"

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

FREQUENCY SELECTION TABLE

Pad #28 SEL3	Pad #29 SEL2	Pad #19 SEL1	Pad #20 SEL0	Selected Multiplier
0	0	1	1	Fin x 8
1	0	1	1	Fin x 4
1	1	1	0	Fin x 2
1	1	1	1	No multiplication (no PLL)

All pads have internal pull-ups (default value is 1). Bond to GND to set to 0.

ELECTRICAL SPECIFICATIONS

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V_{DD}		4.6	V
Input Voltage, dc	V_I	-0.5	$V_{DD}+0.5$	V
Output Voltage, dc	V_O	-0.5	$V_{DD}+0.5$	V
Storage Temperature	T_S	-65	150	°C
Ambient Operating Temperature*	T_A	-40	85	°C
Junction Temperature	T_J		125	°C
Lead Temperature (soldering, 10s)			260	°C
ESD Protection, Human Body Model			2	kV

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

* **Note:** Operating Temperature is guaranteed by design for all parts (COMMERCIAL and INDUSTRIAL), but tested for COMMERCIAL grade only.

2. Crystal Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Built-in Capacitance	CX+	65MHz to 130 MHz (VDD=3.3V)			2	pF
	CX-				2	
Inter-electrode capacitance	C_0			2.6		
C0/C1 ratio (gamma)	γ				350	-
Oscillation Frequency	OF	Fund.	65		130	MHz

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

3. Voltage Control Crystal Oscillator

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
VCXO Stabilization Time *	T _{VCXOSTB}	From power valid			10	ms
VCXO Tuning Range		F _{XIN} = 100 – 200MHz; XTAL C ₀ /C ₁ < 250 0V ≤ VCON ≤ 3.3V		200*		ppm
CLK output pullability		VCON=1.65V, ±1.65V	±100*			ppm
On-chip Varicaps control range		VCON = 0 to 3.3V		4 – 18*		pF
Linearity					10*	%
VCXO Tuning Characteristic				65		ppm/V
VCON input impedance				60		kΩ
VCON modulation BW		0V ≤ VCON ≤ 3.3V, -3dB	25			kHz

Note: Parameters denoted with an asterisk (*) represent nominal characterization data and are not production tested to any specific limits.

4. General Electrical Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Current (Loaded Outputs)	I _{DD}	PECL/LVDS/CMOS			100/80/40	mA
Operating Voltage	V _{DD}		2.97		3.63	V
Output Clock Duty Cycle		@ 50% V _{DD} (CMOS)	45	50	55	%
		@ 1.25V (LVDS)	45	50	55	
		@ V _{DD} – 1.3V (PECL)	45	50	55	
Short Circuit Current				±50		mA

5. Jitter Specifications

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Period jitter RMS	77.76MHz		2.5		ps
	155.52MHz		4		
	622.08MHz		5		
Period jitter peak-to-peak	77.76MHz		24		ps
	155.52MHz		29		
	622.08MHz		32		
Integrated jitter RMS	Integrated 12 kHz to 20 MHz at 77.76MHz		0.5		ps
	Integrated 12 kHz to 20 MHz at 155.52MHz		1.5		
	Integrated 12 kHz to 20 MHz at 622.08MHz		1.5		

6. Phase Noise Specifications

PARAMETERS	FREQUENCY	@10Hz	@100Hz	@1kHz	@10kHz	@100kHz	UNITS
Phase Noise relative to carrier	77.76MHz	-75	-95	-125	-145	-155	dBc/Hz
	155.52MHz	-75	-95	-120	-125	-123	
	622.08MHz	-75	-95	-115	-118	-115	

Note: Phase Noise at VCON = 0V

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

7. CMOS Output Electrical Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output drive current (High Drive)	I_{OH}	$V_{OH} = V_{DD} - 0.4V, V_{DD} = 3.3V$	30			mA
	I_{OL}	$V_{OL} = 0.4V, V_{DD} = 3.3V$	30			mA
Output drive current (Standard Drive)	I_{OH}	$V_{OH} = V_{DD} - 0.4V, V_{DD} = 3.3V$	10			mA
	I_{OL}	$V_{OL} = 0.4V, V_{DD} = 3.3V$	10			mA
Output Clock Rise/Fall Time (Standard Drive)		0.3V ~ 3.0V with 15 pF load		2.4		ns
Output Clock Rise/Fall Time (High Drive)		0.3V ~ 3.0V with 15 pF load		1.2		

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

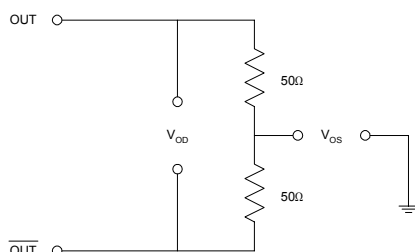
8. LVDS Electrical Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Differential Voltage	V_{OD}	$R_L = 100\ \Omega$ (see figure)	247	355	454	mV
V_{DD} Magnitude Change	ΔV_{OD}		-50		50	mV
Output High Voltage	V_{OH}			1.4	1.6	V
Output Low Voltage	V_{OL}		0.9	1.1		V
Offset Voltage	V_{OS}		1.125	1.2	1.375	V
Offset Magnitude Change	ΔV_{OS}		0	3	25	mV
Power-off Leakage	I_{OXD}	$V_{out} = V_{DD}$ or GND $V_{DD} = 0V$		± 1	± 10	μA
Output Short Circuit Current	I_{OSD}			-5.7	-8	mA

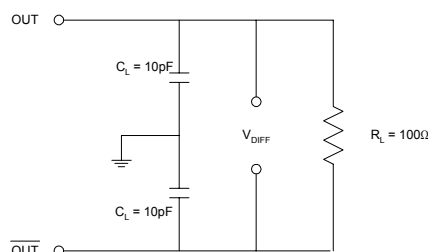
9. LVDS Switching Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Differential Clock Rise Time	t_r	$R_L = 100\ \Omega$ $C_L = 10\ pF$ (see figure)	0.2	0.7	1.0	ns
Differential Clock Fall Time	t_f		0.2	0.7	1.0	ns

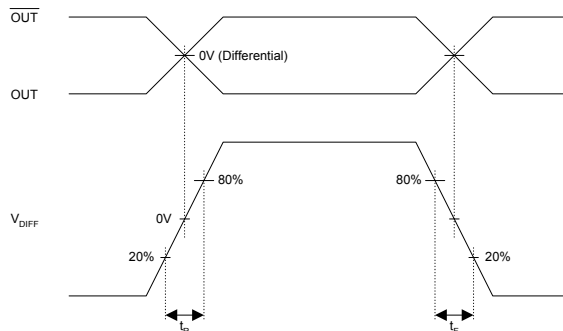
LVDS Levels Test Circuit



LVDS Switching Test Circuit



LVDS Transition Time Waveform



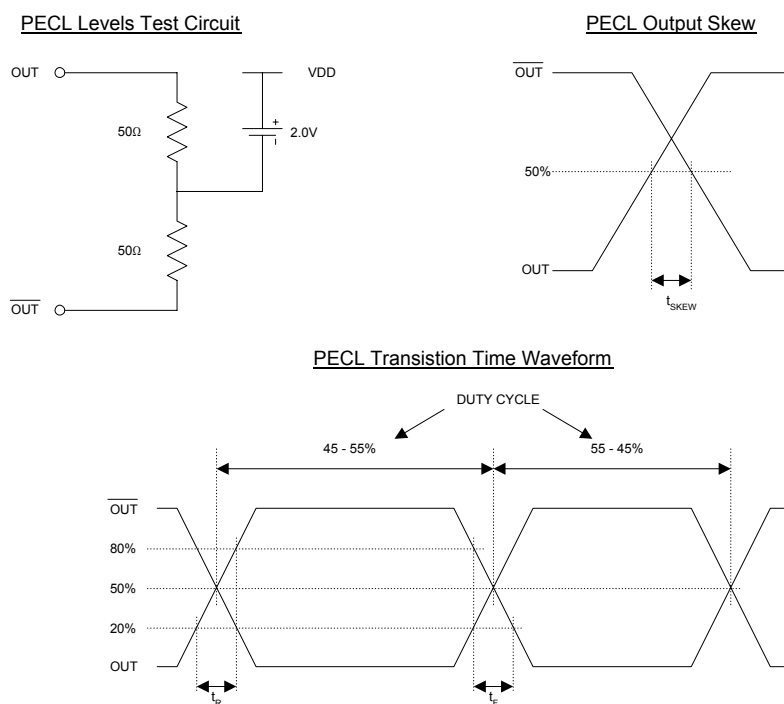
Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

10. PECL Electrical Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	MAX.	UNITS
Output High Voltage	V_{OH}	$R_L = 50\ \Omega$ to $(V_{DD} - 2V)$ (see figure)	$V_{DD} - 1.025$		V
Output Low Voltage	V_{OL}			$V_{DD} - 1.620$	V

11. PECL Switching Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Clock Rise Time	t_r	@20/80% - PECL		0.6	1.5	ns
Clock Fall Time	t_f	@80/20% - PECL		0.5	1.5	ns



Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

PAD ASSIGNMENT

Pad #	Name	X (μm)	Y (μm)	Description
1	GND	248	109	Ground.
2	GND	361	109	Ground.
3	GND	473	109	Ground.
4	GND	587	109	Ground.
5	GND	702	109	Ground.
6	N/C	874	109	No Connection.
7	GND	1042	109	Ground.
8	GNDBUF	1171	109	Ground, Buffer circuitry.
9	OE_SELECT	1400	125	Used to select between PECL or CMOS logic states for OE. Internal pull up.
10	LVDS	1400	259	LVDS output.
11	PECL	1400	476	PECL output.
12	VDDBUF	1400	616	3.3V power supply, Buffer circuitry.
13	VDDBUF	1400	716	3.3V power supply, Buffer circuitry.
14	PECLB	1400	871	Complementary PECL output.
15	LVDSB	1400	1089	Complementary LVDS output.
16	CMOS	1400	1227	CMOS output
17	GNDBUF	1389	1365	Ground, Buffer Circuitry.
18	OUTSEL1	1232	1365	Used to select CMOS, PECL or LVDS output type. Internal pull up.
19	SEL1	1042	1365	Used to select multiplication factor. Internal pull up.
20	SEL0	854	1365	Used to select multiplication factor. Internal pull up.
21	VDD	659	1365	3.3V power supply.
22	VDD	559	1365	3.3V power supply.
23	VDD	459	1365	3.3V power supply.
24	VDD	358	1365	3.3V power supply.
25	OUTSEL0	194	1365	Used to select CMOS, PECL or LVDS output type. Internal pull up.
26	XIN	109	1223	Crystal input. See crystal specification page 2.
27	XOUT	109	1017	Crystal output. See crystal specification page 2.
28	SEL3	109	858	Used to select multiplication factor. Internal pull up.
29	SEL2	109	646	Used to select multiplication factor. Internal pull up.
30	OE_CTRL	109	397	Used to enable/disable the output(s). See Output Selection and Enable table on page 1.
31	VCON	109	181	Voltage control input.

Low Phase Noise VCXO with multipliers (for 65-130MHz Fund Xtal)

ORDERING INFORMATION

For part ordering, please contact our Sales Department:

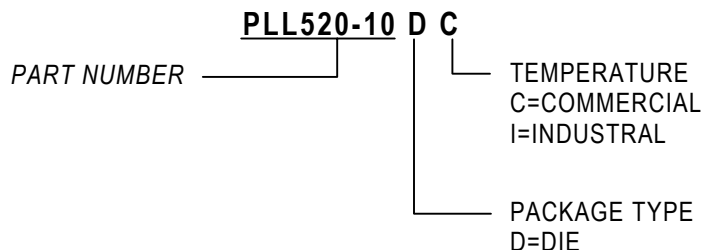
47745 Fremont Blvd., Fremont, CA 94538, USA

Tel: (510) 492-0990 Fax: (510) 492-0991

PART NUMBER

The order number for this device is a combination of the following:

Device number, Package type and Operating temperature range



<u>Order Number</u>	<u>Marking</u>	<u>Package Option</u>
PLL520-10DC	P520-10DC	Die – Waffle Pack

PhaseLink Corporation, reserves the right to make changes in its products or specifications, or both at any time without notice. The information furnished by Phaselink is believed to be accurate and reliable. However, PhaseLink makes no guarantee or warranty concerning the accuracy of said information and shall not be responsible for any loss or damage of whatever nature resulting from the use of, or reliance upon this product.

LIFE SUPPORT POLICY: PhaseLink's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of PhaseLink Corporation.



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331